



05PM

2827

PATENT APPLICATION  
Do. No. 9898-206

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Shin KIM, et al.

Serial No. 10/068,628

Examiner: Dinh, Tuan T

Confirmation No. 6784

Filed: February 6, 2002

Group Art Unit: 2827

For: SEMICONDUCTOR DEVICE BONDING PAD RESISTANT TO STRESS  
AND METHOD OF FABRICATING THE SAMEBOX NON FEE AMENDMENT  
Assistant Commissioner for Patents,  
Washington, D.C. 20231Responsive to the Office Action dated August 14, 2002, enclosed is an amendment in the  
above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	16	20	0	x \$18 =	\$0
Independent Claims	2	3	0	x \$84 =	\$0
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0

\*greater of twenty (20) or number for which fee has been paid

\*\*greater of three (3) or number for which fee has been paid


Respectfully submitted,

MARGER JOHNSON &amp; McCOLLOM, P.C.



20575

PATENT TRADEMARK OFFICE

  
Alan T. McCollom  
Reg. No. 28,881MARGER JOHNSON & McCOLLOM, P.C.  
1030 SW Morrison Street  
Portland, OR 97205  
(503) 222-3613I HEREBY CERTIFY THAT THIS COR-  
RESPONDENCE IS BEING DEPOSITED  
WITH THE UNITED STATES POSTAL  
SERVICE AS FIRST CLASS MAIL IN AN  
ENVELOPE ADDRESSED TO:  
☐ COMMISSIONER OF PATENTS AND  
TRADEMARKS, WASHINGTON D.C.  
20231  
☒ ASSISTANT COMMISSIONER FOR  
PATENTS, WASHINGTON D.C. 20231  
☐ ASSISTANT COMMISSIONER FOR  
TRADEMARKS, 2900 CRYSTAL DRIVE,  
ARLINGTON VA 22202-3513  
ON 11-12-02